



Features

- 4-Pin Dip
- Fast Warm-up
- Frequency Range: 80 MHZ to 120 MHZ
- Low g-sensitivity
- · Low Phase Noise

Applications

- Base Stations
- Test Equipment
- Synthesizers
- Military Communication Equipment

Performance Specifications

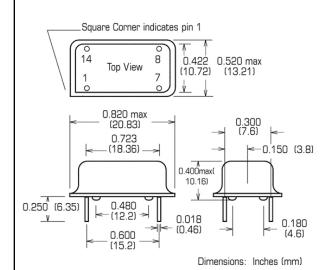
Frequency Stabilities ¹ (SC-Cut Crystal-Option)					
Parameter	Min	Typical	Max	Unit	Condition
vs. operating temperature range (referenced to +25°C)	-200 -150 -100 -50 -35 -25		+200 +150 +100 +50 +35 +25	ppb ppb ppb ppb ppb ppb	-40 to +85°C -20 to +70°C -0 to +70°C -40 to +85°C (height code 0 and 3 only) -20 to +70°C (height code 0 and 3 only) -0 to +70°C (height code 0 and 3 only)
Initial tolerance vs. supply voltage change vs. load change vs. aging/day vs. aging/1st year	-400 -50 -25 -10 -3 -300		+400 +50 +25 +10 +3 +300	ppb ppb ppb ppb ppb ppb	at time of shipment, nominal EFC $V_s\pm5\%$ static (CMOS outputs) $V_s\pm5\%$ static (sine outputs) Load $\pm5\%$ static after 30 days of operation after 30 days of operation
Warm-up time			2	minutes	to ±100ppb of final frequency (1 hour reading) @ +25°C

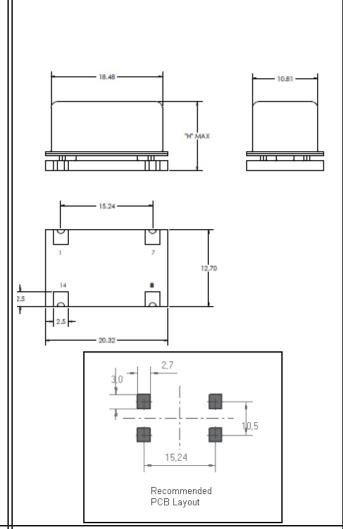
Performance Specifications

Supply Voltage (Vs)						
Parameter Min Typical Max Unit Condition						dition
Supply Voltage	4.75	5.0	5.25	VDC		
	3.165	3.3	3.465	VDC		
			3.5	Watts	during warm-ւ	ıp (5V versions)
Power Consumption			4.5	Watts		up (3V version)
			1.0	Watts	steady state @ +25°C	
	I		RF Output			
Signal [Standard]			MOS	_		
Load		15		pF		
Signal Level (Vol)			0.5	VDC	with Vs=5V and 15 pF Load	
Signal Level (Voh)	4.7			VDC		nd 15 pF Load
Signal Level (Vol)			0.3	VDC	with Vs=3.3V and 15 pF Load	
Signal Level (Voh)	3.0			VDC	with Vs=3.3V and 15 pF Load	
Duty Cycle	40		60	%	@ (Voh	n-Vol)/2
	Sinewave	(5V supply, I	neight code (or 3 only)		
Load		50		Ω		
Output Power @ 5V	5	8	11	dBm	50 Ω	load
Harmonics			-40	dBm		
		Freque	ncy Tuning	(EFC)		
Tuning Range	±1.0		±3.0	ppm		
Linearity			5	%		
Tuning Slope		Pos	itive			
Control Voltage Range	0.0	2.0	4.0	VDC	5 V versions	
	0	1.5	3.0	VDC	3.3 V versions	
		Additio	onal Param	eters		
			-95	dBc/Hz	10 Hz	
Phase Noise ³			-125 -145	dBc/Hz dBc/Hz	100 Hz 1 kHz	@ 100MHz
Thuse Woise			-155	dBc/Hz	10 kHz	@ 1001/1112
			-160	dBc/Hz	100 kHz	
G-Sensitivity			1	ppb/g	worst direction - standard	
			0.5			
Weight			0.5 8	ppb/g		quest a custom part
Weight		Absolute	8	ppb/g g		
		Absolute	8 Maximum	ppb/g g Ratings		
Supply Voltage (Vs)		Absolute	8 Maximum 6.0	ppb/g g Ratings V		
Supply Voltage (Vs) Output Load	-55	Absolute	8 Maximum 6.0 50	ppb/g g Ratings V pF		
Supply Voltage (Vs)	-55		8 Maximum 6.0 50 +85	ppb/g g Ratings V pF °C	worst direction - re	
Supply Voltage (Vs) Output Load Operable Temperature Range	Envir	onmental a	8 Maximum 6.0 50 +85 and Produc	ppb/g g Ratings V pF °C t Classification	worst direction - re	
Supply Voltage (Vs) Output Load Operable Temperature Range Shock (Endurance)	Envir MIL-STD-202,	onmental o	8 Maximum 6.0 50 +85 and Produc , Condition J	ppb/g g Ratings V pF °C t Classification , 30 g 11 ms	worst direction - re	quest a custom part
Supply Voltage (Vs) Output Load Operable Temperature Range Shock (Endurance) Sine Vibration (Endurance)	Envir MIL-STD-202, MIL-STD-202,	onmental a Method 213 Method 201	8 Maximum 6.0 50 +85 and Produc , Condition J and 204, Co	ppb/g g Ratings V pF °C t Classification , 30 g 11 ms	worst direction - re	quest a custom part
Supply Voltage (Vs) Output Load Operable Temperature Range Shock (Endurance) Sine Vibration (Endurance) Random Vibration (Endurance)	Envir MIL-STD-202, MIL-STD-202, MIL-STD-202,	onmental of Method 213 Method 201 Method 214	8 Maximum 6.0 50 +85 and Produc , Condition J and 204, Cc	ppb/g g Ratings V pF °C t Classification , 30 g 11 ms endition A, exce	worst direction - re	quest a custom part
Supply Voltage (Vs) Output Load Operable Temperature Range Shock (Endurance) Sine Vibration (Endurance) Random Vibration (Endurance) Humidity	Envir MIL-STD-202, MIL-STD-202, MIL-STD-202,	onmental of Method 213 Method 201 Method 214 Method 103	8 Maximum 6.0 50 +85 and Produc , Condition J and 204, Cc , Condition I-	ppb/g g Ratings V pF °C t Classification , 30 g 11 ms endition A, exce	worst direction - re	quest a custom part
Supply Voltage (Vs) Output Load Operable Temperature Range Shock (Endurance) Sine Vibration (Endurance) Random Vibration (Endurance) Humidity Seal	Envir MIL-STD-202, MIL-STD-202, MIL-STD-202, MIL-STD-202,	Method 213 Method 201 Method 214 Method 103 Method 112	8 Maximum 6.0 50 +85 and Produc , Condition J and 204, Cc , Condition I- , Condition B	ppb/g g Ratings V pF °C t Classification , 30 g 11 ms endition A, exce	worst direction - re	quest a custom part
Supply Voltage (Vs) Output Load Operable Temperature Range Shock (Endurance) Sine Vibration (Endurance) Random Vibration (Endurance) Humidity Seal Altitude	Envir MIL-STD-202, MIL-STD-202, MIL-STD-202, MIL-STD-202, MIL-STD-202,	onmental of Method 213 Method 201 Method 214 Method 103 Method 112 Method 105	8 Maximum 6.0 50 +85 and Produc , Condition J and 204, Cc , Condition I- , Condition E , Condition E	ppb/g g Ratings V pF °C t Classification , 30 g 11 ms Indition A, exceed D S, 100% rh D Space	worst direction - re	quest a custom part
Supply Voltage (Vs) Output Load Operable Temperature Range Shock (Endurance) Sine Vibration (Endurance) Random Vibration (Endurance) Humidity Seal Altitude Resistance to Soldering Heat	Envir MIL-STD-202, MIL-STD-202, MIL-STD-202, MIL-STD-202, MIL-STD-202, MIL-STD-202,	Method 213 Method 201 Method 214 Method 103 Method 112 Method 105 Method 210	8 Maximum 6.0 50 +85 and Produc , Condition J and 204, Co , Condition B , Condition E , condition C , sea level to	ppb/g g Ratings V pF °C t Classification , 30 g 11 ms andition A, exce D 6, 100% rh 0) space A,B,C	worst direction - re	quest a custom part
Supply Voltage (Vs) Output Load Operable Temperature Range Shock (Endurance) Sine Vibration (Endurance) Random Vibration (Endurance) Humidity Seal Altitude Resistance to Soldering Heat Terminal Strength	Envir MIL-STD-202, MIL-STD-202, MIL-STD-202, MIL-STD-202, MIL-STD-202, MIL-STD-202, MIL-STD-202,	Method 213 Method 201 Method 214 Method 103 Method 112 Method 105 Method 210	8 Maximum 6.0 50 +85 and Produc , Condition J and 204, Co , Condition B , Condition E , condition C , sea level to	ppb/g g Ratings V pF °C t Classification , 30 g 11 ms Indition A, exceed D S, 100% rh D Space	worst direction - re	quest a custom part
Supply Voltage (Vs) Output Load Operable Temperature Range Shock (Endurance) Sine Vibration (Endurance) Random Vibration (Endurance) Humidity Seal Altitude Resistance to Soldering Heat Terminal Strength Moisture Sensitivity level	Envir MIL-STD-202, MIL-STD-202, MIL-STD-202, MIL-STD-202, MIL-STD-202, MIL-STD-202, MIL-STD-202,	Method 213 Method 201 Method 214 Method 103 Method 112 Method 105 Method 210	8 Maximum 6.0 50 +85 and Produc , Condition J and 204, Co , Condition B , Condition E , condition C , sea level to	ppb/g g Ratings V pF °C t Classification , 30 g 11 ms andition A, exce D 6, 100% rh 0) space A,B,C	worst direction - re	quest a custom part
Supply Voltage (Vs) Output Load Operable Temperature Range Shock (Endurance) Sine Vibration (Endurance) Random Vibration (Endurance) Humidity Seal Altitude Resistance to Soldering Heat Terminal Strength	Envir MIL-STD-202, MIL-STD-202, MIL-STD-202, MIL-STD-202, MIL-STD-202, MIL-STD-202, MIL-STD-202,	Method 213 Method 201 Method 214 Method 103 Method 112 Method 105 Method 210	8 Maximum 6.0 50 +85 and Produc , Condition J and 204, Co , Condition B , Condition E , condition C , sea level to	ppb/g g Ratings V pF °C t Classification , 30 g 11 ms andition A, exce D 6, 100% rh 0) space A,B,C	worst direction - re	quest a custom part

Performance Specifications

Outline Drawing / Enclosure



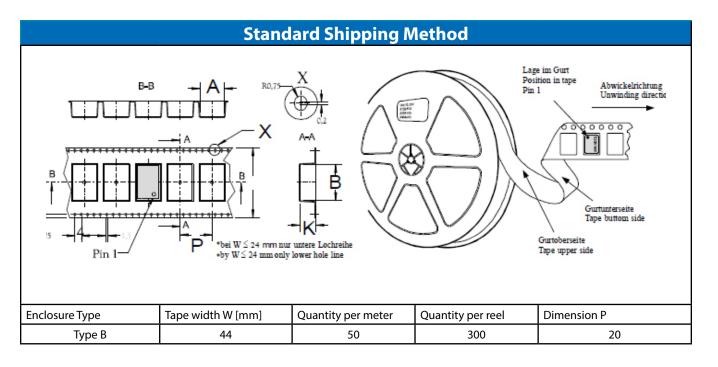


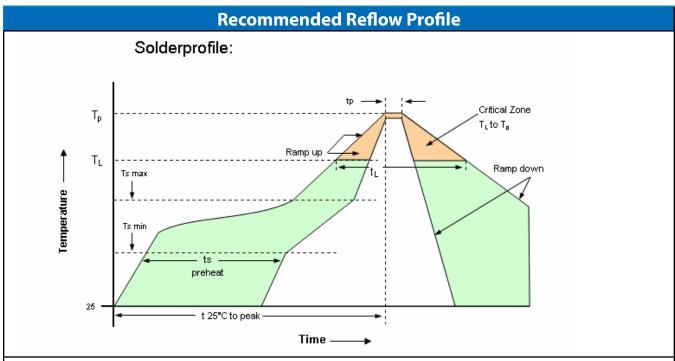
Dimensions in inches (mm)

	Турє	pe A			
Code	Height "H"	Pin Length "L" Min			
0	9.3	5.85			
1	8.3	5.85			
Pin Connections					
1	Electronic Frequency Control Input (EFC)				
7	Ground (Case)				
8	RF Output				
14	Supply Voltage Input (VS)				

Dimensions in mm

	Туре	e B			
Code	Height "H"	Pin Length "L" Min			
2	10.4	NA			
3	11.4	NA			
	Pin Connections				
1	Electronic Frequency Control Input (EFC)				
7	Ground (Case)				
8	RF Output				
14	Supply Voltage Input (VS)				

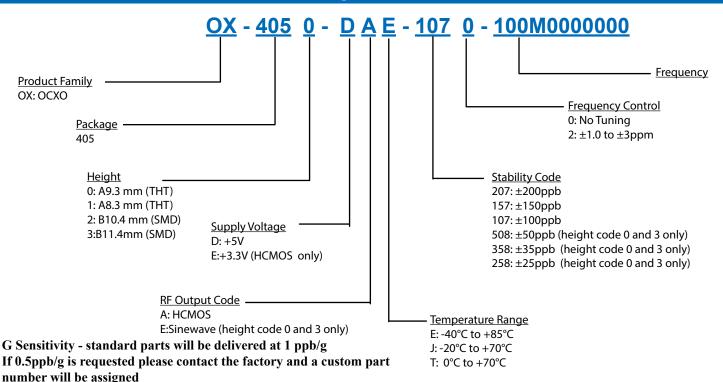




Profile Feature	Pb-Free Assembly /Sn-Pb Assembly	Profile Feature	Pb-Free Assembly /Sn-Pb Assembly
Average ramp-up rate (T _L to Tp)	3°C/second max.	Time 25°C to Peak Temperature	8 minutes max.
Preheat -Temperature Min Ts _{min}) -Temperature Min Ts _{max}) -Time (min to max) (ts)	150°c 200°c 60-180 seconds	Time maintainted above - Temperature (T _L) - Time (t _L)	217°C 60-150 seconds
Ts _{max} to T _L - Ramp-up Rate	3°C/second max.		
Time maintainted above - Temperature (T _L) - Time (t _L)	217°C 60-150 seconds	Time within 5°C of actual Peak Temperature (tp)	20-40 seconds
Peak Temperature (Tp)	max 260°C	Ramp-down Rate	6°C/second max.

Note: All temperatures refer to topside of the package, measured on the package body surface.

Ordering Information



Notes:

- 1. Contact factory for improved stabilities or additional product options. Not all options and codes are available at all frequencies
- 2. Unless other stated all values are valid after warm-up time and refer to typical conditions for supply voltage, frequency control voltage, load, temperature (25°C).
- 3. Phase noise degrades with increasing output frequency.
- 4. Subject to technical modification.
- Contact factory for availability.

Contact Information

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